





ATTY DKT. No.:  
U.S. SERIAL No.:  
FILED:  
APPLICANT:  
TITLE:  
INVENTOR:

AMAT/4471.Y1/CMP/ECP/RKK  
09/614,407  
JULY 12, 2000  
APPLIED MATERIALS, INC.  
METHOD OF APPLICATION OF ELECTRICAL BIASING TO ENHANCE  
METAL DEPOSITION  
ZHENG, ET AL.

CONF. No.: 1903

PAGE 2 of 7

2/7

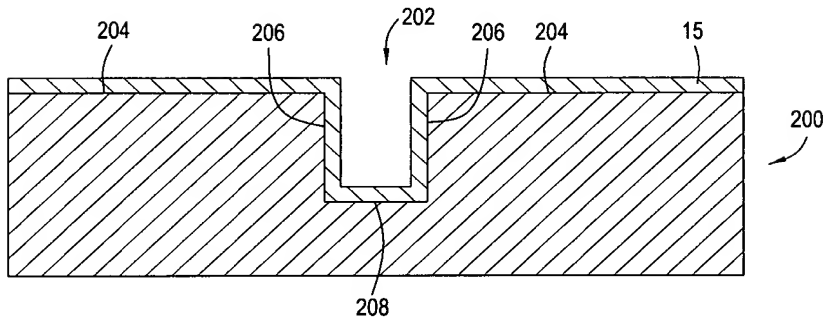


FIG. 2A

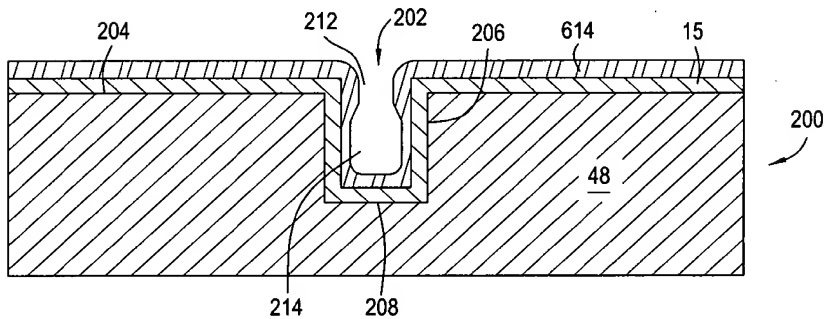


FIG. 2B



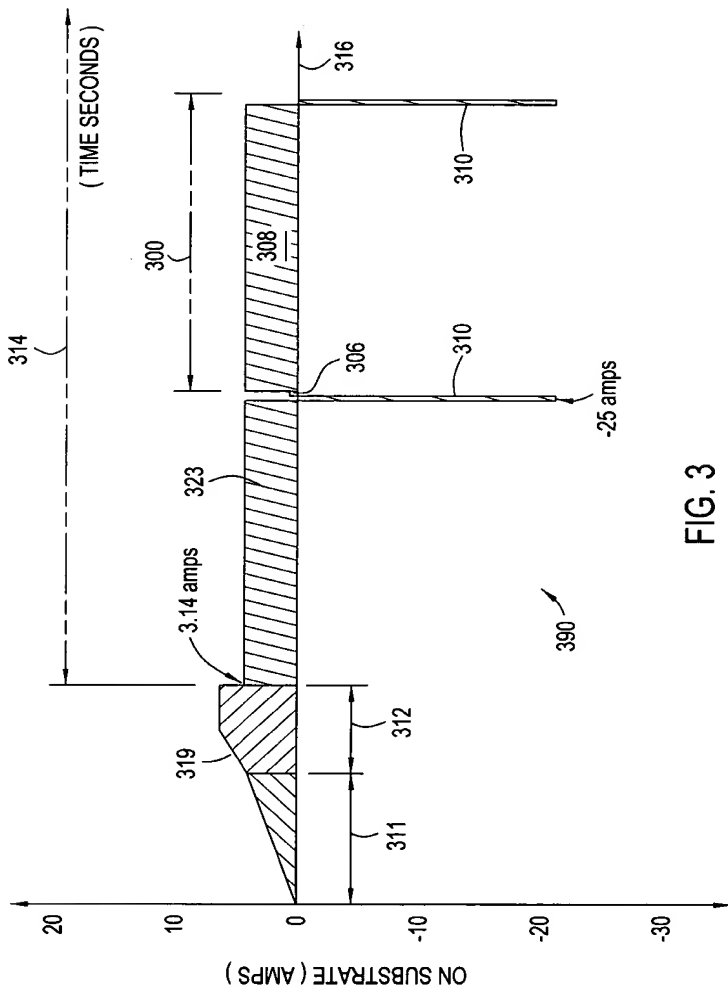
ATTY DKT. NO.:  
U.S. SERIAL NO.:  
FILED:  
APPLICANT:  
TITLE:  
INVENTOR:

AMAT/4471.Y1/CMP/ECP/RKK  
09/614,407  
JULY 12, 2000  
APPLIED MATERIALS, INC.  
METHOD OF APPLICATION OF ELECTRICAL BIASING TO ENHANCE  
METAL DEPOSITION  
ZHENG, ET AL.

CONF. NO.: 1903

PAGE 3 of 7

3/7





4/7

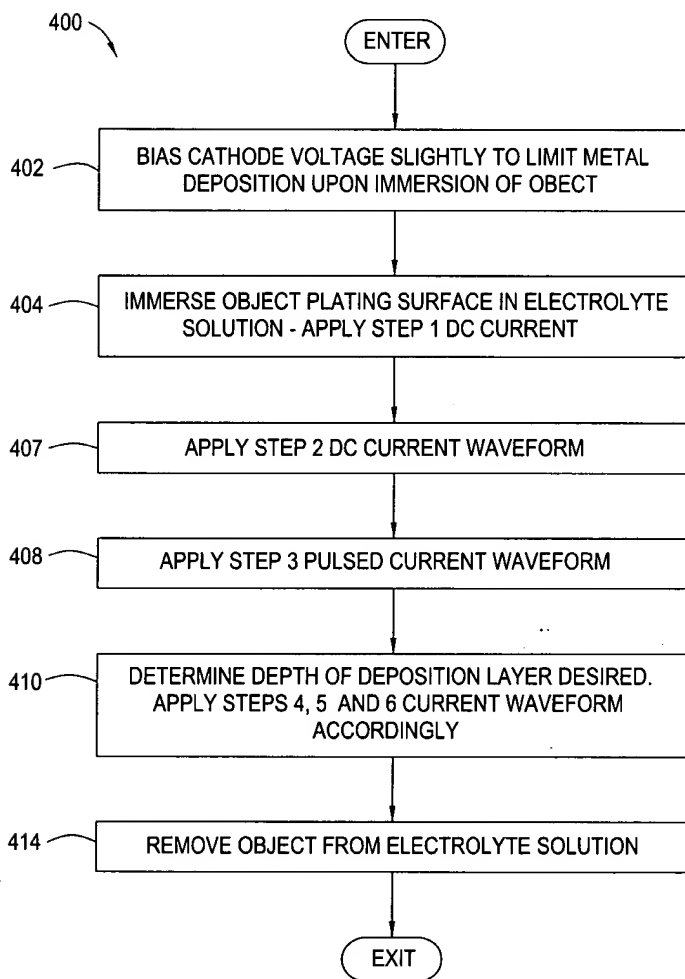


FIG. 4





ATTY DKT. No.:  
U.S. SERIAL No.:  
FILED:  
APPLICANT:  
TITLE:  
INVENTOR:

AMAT/4471.Y1/CMP/ECP/RKK  
09/614,407  
JULY 12, 2000  
APPLIED MATERIALS, INC.  
METHOD OF APPLICATION OF ELECTRICAL BIASING TO ENHANCE  
METAL DEPOSITION  
ZHENG, ET AL.

CONF. No.: 1903

PAGE 6 of 7

6/7

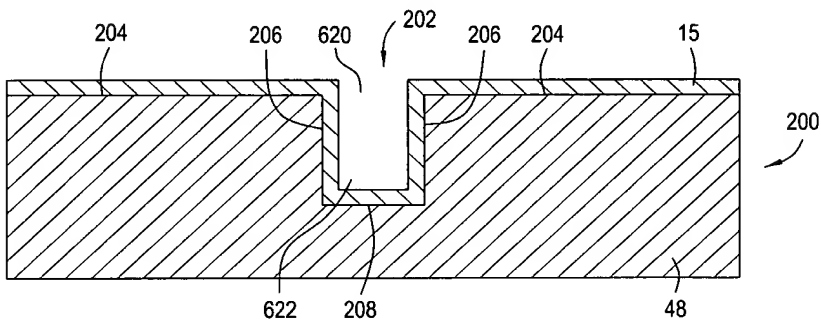


FIG. 6A

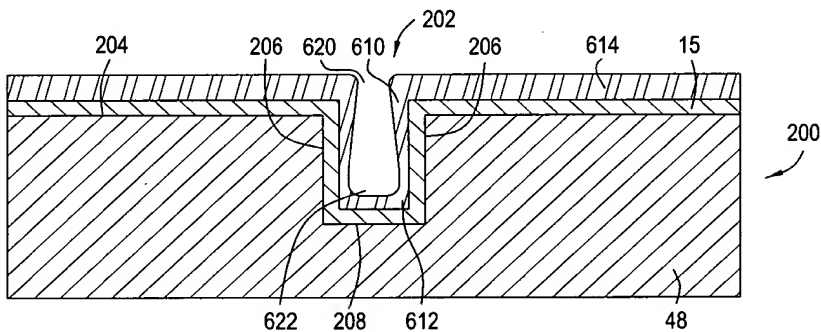


FIG. 6B

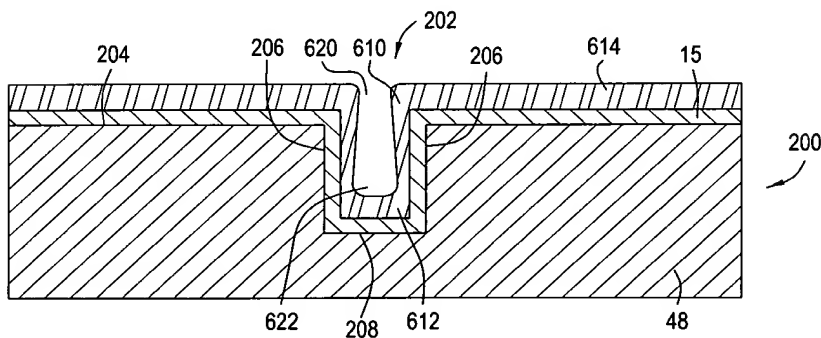


FIG. 6C

FIG. 6F